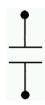


Piezoelectric Noise: MLCC Ringing - Singing



Possible solutions for reducing or eliminating MLCC ringing – singing issues

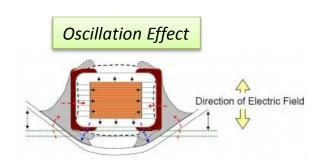
- Modified PCB materials or layout (page 3)
- Lower K Dielectric MLCCs (page 4)
- SMT Film Capacitors (pages 5 ~ 16)

Piezoelectric effect in MLCCs (Multilayer Ceramic Chip Capacitors)

MLCCs (Multi Layer Ceramic Capacitor) have several advantages

- low Equivalent Series Resistance (ESR)
- low Equivalent Series Inductance (ESL)
- small size
- non-polarized

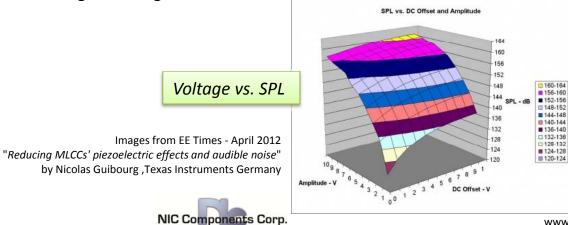
A disadvantage of the MLCC can be the piezoelectric nature of the ceramic material. MLCCs are made from ceramic dielectrics (which have ferroelectric properties), which can exhibit problematic or disruptive noise (ringing or singing) due to oscillations with PCB.



Contributors to Ringing – Singing Noise in circuits using MLCCs:

- Operating frequency of signal (or harmonics) within the audible range (20Hz ~ 20KHz)
- Operating voltage ... higher signal voltage produces higher SPL (sound pressure level)
- Ceramic dielectric constant (K) ... Higher K ceramics exhibit higher ferroelectric properties
- Ceramic layer thickness ... Higher voltage rated MLCVC have thicker ceramic layers and typical

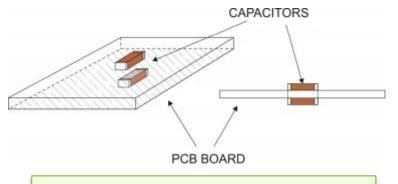
exhibit lower SPL



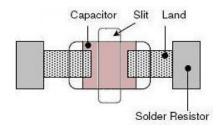
Contributors to Ringing – Singing Noise in circuits using MLCCs:

PCB = Printed Circuit Board

- PCB material and thickness ... The thicker the PCB, more resistant it is to deformation and the lower SPL it produces
- PCB layout
 - MLCC capacitor placed at the edge of the PCB will be preferred (lower SPL) to placement away from edge of PCB.
 - Placed next to each other, MLCC capacitors generate higher overall SPL (+14 dB between a single capacitor and three placed in parallel).
 - On the contrary, when placed symmetrically on each side (opposite sides) of the PCB board *as shown in below figure*, MLCC capacitors tend to cancel out each other's vibrations.



Oscillation effects reduced when mounting MLCCs symmetrically opposite one another



Slit in PCB added under MLCC can help to reduce coupling to PCB and reduce SPL

Image from EE Times - April 2012

by Nicolas Guibourg ,Texas Instruments Germany



[&]quot;Reducing MLCCs' piezoelectric effects and audible noise"

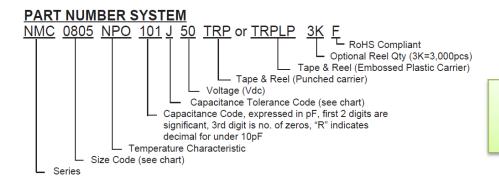
Potential Remedies

Goal: Reduce SPL to acceptable levels

- Use MLCC with lower dielectric constant (K)
- Replace high K dielectrics Y5V / X5R / X7R with NPO dielectric (low K)
- Below table shows maximum capacitance values for 50V, 100V and 250V rating in NPO dielectric MLCCs

(3-digit capacitance code & corresponding capacitance value) for 0402 case size to 2225 case size

	0402	0603	0805	1206	1210	1808	1812	2220	2225
F0\/	471	332	153	223	223	473	104	224	224
100V	(470pF)	(3300pF)	(0.015uF)	(0.022uF)	(0.022uF)	(0.047uF)	(0.10uF)	(0.22uF)	(0.22uF)
		102	103	223	223	333	823	104	104
		(1000pF)	(0.01uF)	(0.022uF)	(0.022uF)	(0.033uF)	(0.082uF)	(0.10uF)	(0.10uF)
250V		471	392	103	103	223	473	823	823
2500		(470pF)	(3900pF)	(0.01uF)	(0.01uF)	(0.022uF)	(0.047uF)	(0.082uF)	(0.082uF)



Added benefit of using **NPO** is far greater stability over voltage, temperature and time as compared to X7R / X5R / Y5V dielectric

X7R



NSPH Series - SMT Film Chip Capacitors

- Page 6 Introduction
- Page 7 CV Sizes
- Page 8 Construction & Advantages
- Page 9 Voltage Coefficient Comparison
- Page 10 Temperature Coefficient Comparison
- Page 11 Leakage Current Comparison
- Page 12 Low Noise (distortion) Comparison
- Page 13 Dielectric Absorption Comparison
- Page 14 CV Sizes Compared to MLCCs
- Pages 15 & 16 Applications & Replacing LDD types

NSPH series, High Capacitance SMT Film Chip Capacitors



NIC Components is pleased to announce the addition of NSPH series of High Capacitance Multilayer Polymer Film SMT Chip Capacitors. Supplied in four EIA surface mount cases sizes; 1206, 1210, 1812 & 2220 in capacitance values from 0.1 uF to 22 uF with voltage ratings from $16 \text{V} \sim 63 \text{VDC}$ ($11 \text{V} \sim 45 \text{Vrms}$). NSPH series is rated for operating temperatures of -55°C to +125°C with typical capacitance change within $\pm 5\%$ of 25°C capacitance value.

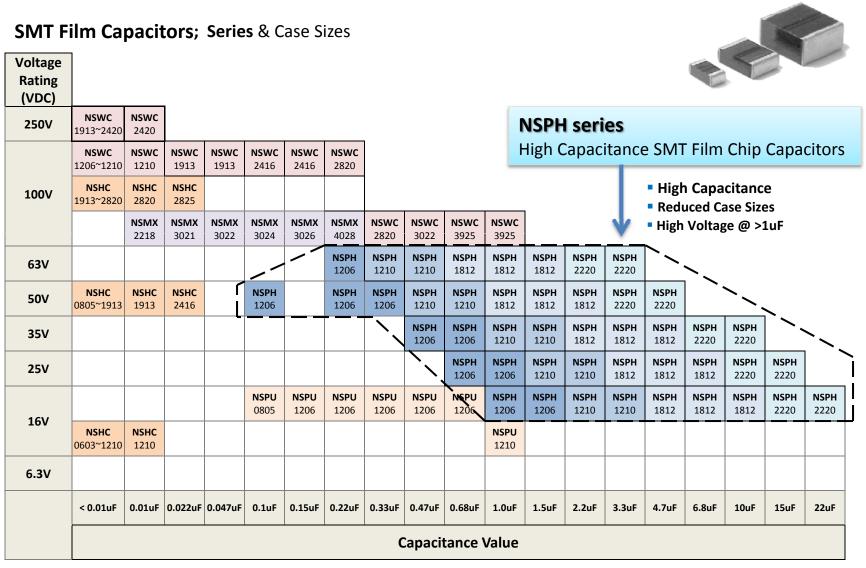
NSPH series is RoHS compliant and is halogen free. Supplied tape and reel packaged, for high speed automated placement and compatible with high temperature Pb-Free alloy soldering (+260degC soldering heat rated). NSPH unit pricing range from $0.39 \sim 1.09$ with production lead times of 8 to 10 weeks. Please contact NIC today for Free component samples and to review your requirements.

Features:

- High Capacitance in Small Case Sizes
- Stable Cap Value over Voltage, Temperature & Time
- Low Noise for Digital Audio Streamer applications
- Reduce or eliminate MLCC Piezoelectric Effects
 - Capacitor singing or ringing effects
- Low Dielectric Absorption for use in A to D applications (10X
- ~ 20X improvement over X7R MLCCs)

- Self healing construction (open mode failure)
 - Free of component cracking failures (MLCC weakness)
- High IR; low leakage current performance (compared to high cap X5R MLCCs)
- Replace large leaded film capacitors with small low profile (low ESL) SMT chip
- RoHS compliant and Halogen Free

SMT Film Capacitors; Series & Case Sizes

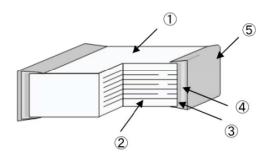




CONSTRUCTION

	Part	Materials				
1	Capacitor Element	Acrylic base polymer film				
2	Internal Electrode	Vapor deposited aluminum				
3	First Termination Layer	Copper alloy				
4	Second Termination Layer	Conductive paste				
5	Third Termination Layer	100% Sn (tin) plating				





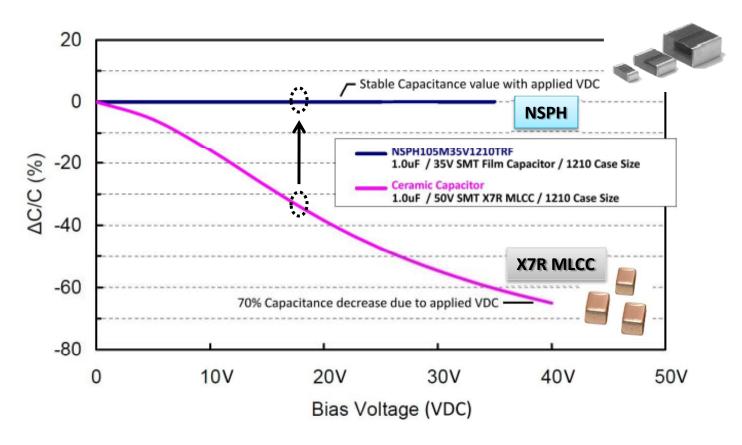
NSPH is ideal for use in green power, network infrastructure, instrumentation, high-end audio, digital audio streaming equipment and audio DAC applications.

NSPH series have many advantages over high capacitance MLCCs (X5R& X7R) capacitors:

- ✓ Higher voltage ratings (15uF & 22uF)
- ✓ Stability over voltage, temperature and time
- ✓ The low loss film construction is **free from piezoelectric noise** (MLCC distortion)
- ✓ Free from MLCC cracking failures
- ✓ Superior low leakage current characteristics for green power applications (high efficiency)
- ✓ **Low dielectric absorption** characteristics, 10X ~ 20X improvement over X7R MLCCs
- ✓ Open-mode failure advantage of NSPH series, compared to short-circuit failure mode of MLCC capacitors.

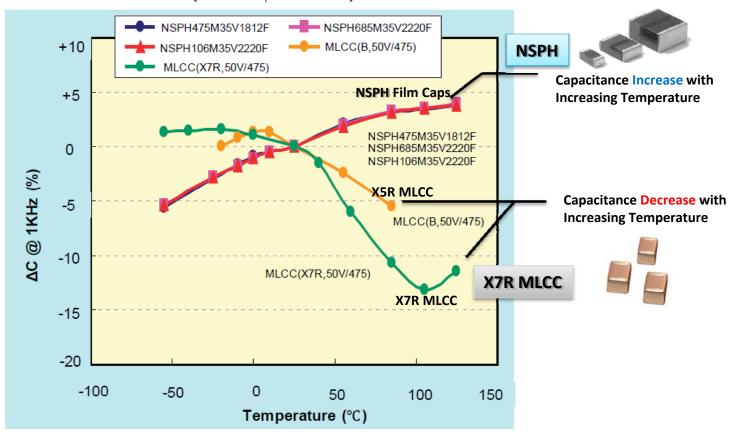


NSPH stability advantage over high capacitance MLCCs capacitors



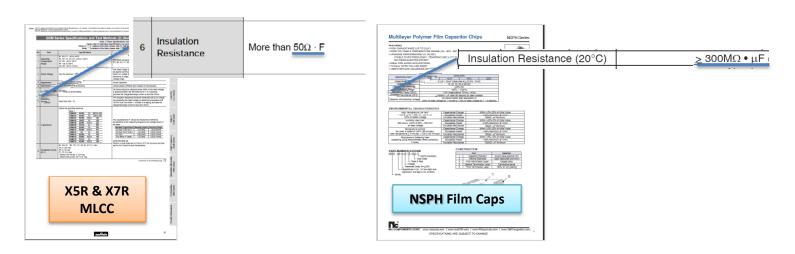
NSPH advantage over high capacitance MLCCs capacitors

Typical Capacitance vs. Temperature (NSPH vs. MLCC)

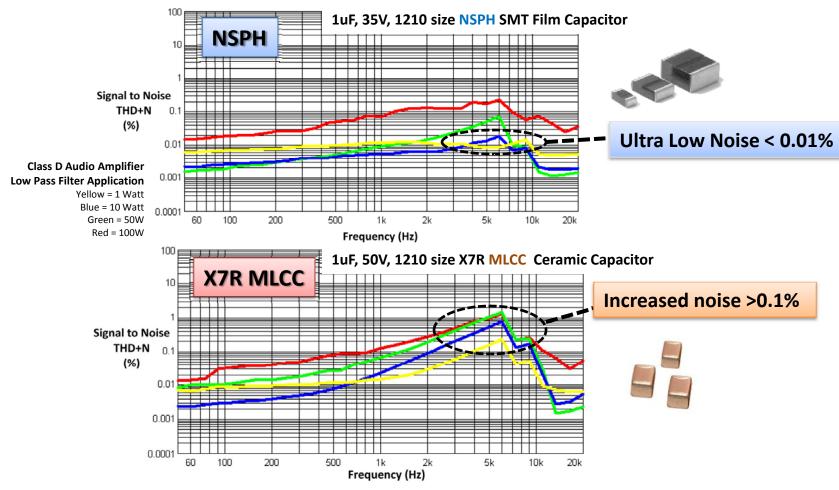


NSPH lower leakage current advantage compared to high capacitance MLCCs capacitors

		Туре	IR Insulation Resistance	22uF Capacitor Leakage Current @ 5VDC Operation	Using 4 Capacitors Energy Loss due to Capacitor LC			
	NSPH	NSPH Film Cap	> 300MΩ • μF	0.37 uA	up to 1.5 uA	← 6 X Improvement		
X7	R MLCC	MLCC X5R & X7R	" > 50Ω • F " > 50ΜΩ • μF	I 2.2uA	up to 8.8uA			



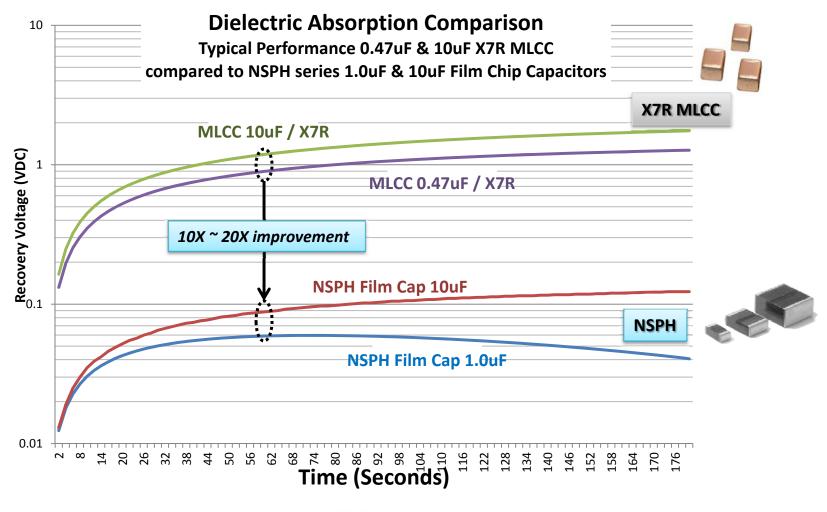
NSPH lower distortion advantages over high capacitance MLCCs capacitors



THD+N is a sum of harmonic distortion components and noise



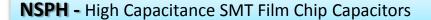
NSPH lower dielectric absorption advantages over high capacitance MLCCs capacitors



SMT Ceramic MLCC Capacitors; TCs & Case Sizes

Voltage Rating												
(VDC)							1	NSPH seri	es			
100V	X7R 1210, 1812, 1825, 2220, 2225	X7R 1210, 1812, 1825, 2220, 2225	X7R 1210, 1812, 2220, 2225	X7R 2220 & 2225	X7R 2220 & 2225		H	ligh Capac	itance SMT	Film Chip	Capacitors	
50V	X7R 0805, 1206, 1210 1812, 1825, 2220		X7R 1210, 1812, 1825, 2220	X7R 1812, 1825, 2220	X7R 1812, 1825, 2220	X7R 2220	X7R 2220					
35V				NSPH 1812	X7R 1210		NSPH 2220	← Advantage NSPH			Br.	
334			X5R 1210	↑ Advantage NSPH		◆ Advantage NSPH	X5R 1210				iew to assure N	SPH
25V	X7R 0805, 1206, 1210 1812, 2225	X7R 2225	X7R 1206, 1210, 2225	X7R 1206 & 1210	X7R 1206	NSPH 2220	X7R 1210 & 1812				uit voltage and ents of circuit	currer
	X5R 0603 & 0805		X5R 0805 & 1206	X5R 1206	X5R 1206 & 1210	NSPH 1812	X5R 1206 & 1210	NSPH 2220				
16V	X7R 0603, 0805, 1206 1210, 1812			X7R 1206	X7R 0805, 1206, 1210		X7R 1206 & 1210	NSPH 2220	NSPH 2220			
	X5R 0402, 0603, 0805	X5R 1206	X5R 0603, 0805, 1206	X5R 1206	X5R 0805, 1206, 1210	NSPH 1812	X5R 0805, 1206, 1210)	X5R 1206 & 1210			
	X7R 0603, 0805, 1206 1210, 1812			X7R 1206	X7R 0805, 1206, 1210		X7R 1206 & 1210					
10V	X5R 0402, 0603, 0805		X5R 0402, 0603, 0805, 1206	X5R 0805 & 1206	X5R 0603,0805 , 1206, 1210		X5R 0805, 1206, 1210)	X5R 1206 & 1210			
6.3V				X7R 0805	X7R 0805		X7R 1206					
	X5R 0402, 0603, 0805		X5R 0402	X5R 0603, 0805, 1206	X5R 0402, 0603,0805 , 1206, 1210	X5R 1206	X5R 0805, 1206, 1210)	X5R 0603, 0805, 1206	X5R 1206 & 1210	X5R 1210	
4V							X5R 0603			X5R 1206		
	1.0uF	1.5uF	2.2uF	3.3uF	4.7uF	6.8uF	10uF	15uF	22uF	47uF	100uF	
		Capacitance Value										







Small SMT Film Capacitors **NSPH** series

NSPH series, SMT Film capacitors contribute to "excellent sound reproduction and very low distortion" ... in Audio Streamer products, decoding FLAC, WAV, MP3 and Ogg Vorbis digital audio files using ARM Cortex-M4 embedded processor

100nF (0.1uF) /1206 / NSPH/20% /50V = PN: NSPH104M50V1206TRF

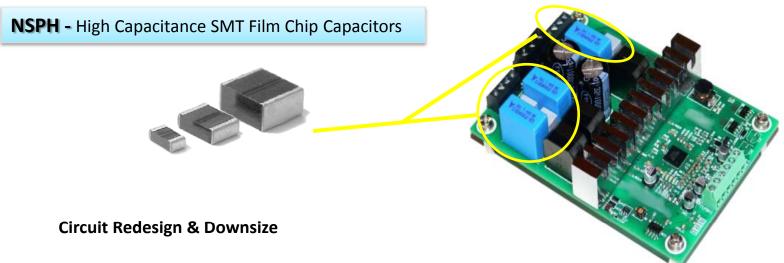
10uF/1812/NSPH/20%/16V = PN: NSPH106M16V1812TRF

Applications:

- High-End Audio
- Digital audio streaming and audio DAC applications
- Battery Powered: Handheld & Portable Devices
- Green Power
- Test & Instrumentation
- Network Infrastructure



ELECTRONICS



Small SMT type NSPH series can replace large leaded polypropylene film capacitors

* Please review to assure NSPH meets circuit voltage and current requirements of circuit

EIA surface mount cases sizes

- 1206 (3.2mm x 1.6mm x 1.6mm)
- 1210 (3.2mm x 2.5mm x 2.2mm)
- 1812 (4.5mm x 3.2mm x 2.8mm)
- **2220** (5.7mm x 5.0mm x 2.8mm)

Downsize from large radial leaded film capacitor in **18mmx 18mm x 9mm size** to small SMT film

capacitor in 5.7mm x 5.0mm x 2.8mm size

Capacitance = 10µF

Voltage Rating AC = 40V (63VDC)

Dielectric Material = Polyester

Package / Case = Radial Box Type

Size / Dimension L x W = 18.0mm x 9.0mm

Height (Max) H = 17.5mm

Lead Spacing LS = 15.00mm



Additional Information Needed? Need Samples?

Technical Support: tpmg@niccompcom

Sales Support: sales@niccomp.com

European Engineering Support

North America Engineering Support

SE Asia Engineering Support

NIC Components offers **unique performance passive components** that provide advantages to design engineers to create high performance end products in smaller and lower total cost formats

- Surface Mount SMT formats (high speed auto placement)
 - Pb-Free Reflow Compatible (high temperature reflow)
- Performance advantages over competing technologies

